

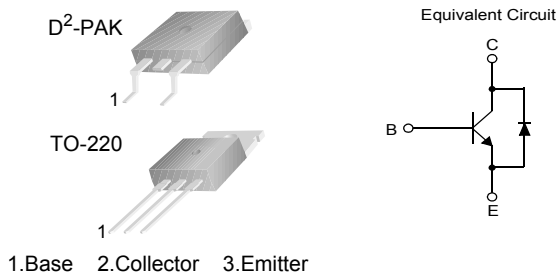


# KSC5338D/KSC5338DW

## NPN Triple Diffused Planar Silicon Transistor

### Features

- High Voltage Power Switch Switching Application
- Wide Safe Operating Area
- Built-in Free-Wheeling Diode
- Suitable for Electronic Ballast Application
- Small Variance in Storage Time
- Two Package Choices : TO-220 or D<sup>2</sup>-PAK



### Absolute Maximum Ratings $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
$V_{CBO}$	Collector-Base Voltage	1000	V
$V_{CEO}$	Collector-Emitter Voltage	450	V
$V_{EBO}$	Emitter-Base Voltage	12	V
$I_C$	Collector Current (DC)	5	A
$I_{CP}$	*Collector Current (Pulse)	10	A
$I_B$	Base Current (DC)	2	A
$I_{BP}$	*Base Current (Pulse)	4	A
$P_C$	Power Dissipation ( $T_C=25^\circ\text{C}$ )	75	W
$T_J$	Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature	- 55 to 150	$^\circ\text{C}$

\* Pulse Test : Pulse Width = 5ms, Duty Cycle  $\leq$  10%

### Thermal Characteristics

Symbol	Parameter	Rating	Units	
$R_{\theta jc}$	Thermal Resistance	Junction to Case	1.65	$^\circ\text{C}/\text{W}$
$R_{\theta ja}$		Junction to Ambient	62.5	$^\circ\text{C}/\text{W}$
$T_L$	Maximum Lead Temperature for Soldering		270	$^\circ\text{C}$

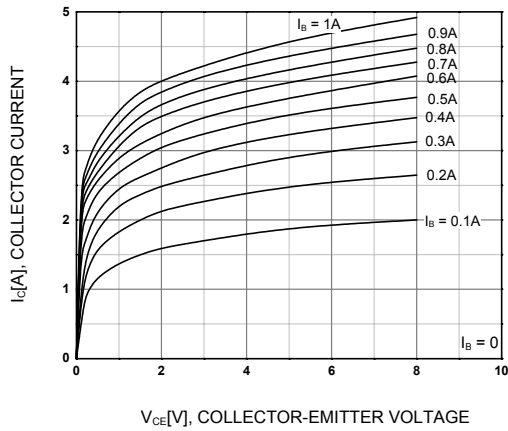
**Electrical Characteristics**  $T_a=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units			
$BV_{CBO}$	Collector-Base Breakdown Voltage	$I_C=1\text{mA}, I_E=0$	1000			V			
$BV_{CEO}$	Collector-Emitter Breakdown Voltage	$I_C=5\text{mA}, I_B=0$	450			V			
$BV_{EBO}$	Emitter-Base Breakdown Voltage	$I_E=1\text{mA}, I_C=0$	12			V			
$I_{CBO}$	Collector Cut-off Current	$V_{CB}=800\text{V}, I_E=0$			10	$\mu\text{A}$			
$I_{CES}$	Collector Cut-off Current	$V_{CES}=1000\text{V}, I_{EB}=0$	$T_a=25^\circ\text{C}$		100	$\mu\text{A}$			
			$T_a=125^\circ\text{C}$		500	$\mu\text{A}$			
$I_{CEO}$	Collector Cut-off Current	$V_{CE}=450\text{V}, I_B=0$	$T_a=25^\circ\text{C}$		100	$\mu\text{A}$			
			$T_a=125^\circ\text{C}$		500	$\mu\text{A}$			
$I_{EBO}$	Emitter Cut-off Current	$V_{EB}=10\text{V}, I_C=0$			10	$\mu\text{A}$			
$h_{FE}$	DC Current Gain	$V_{CE}=1\text{V}, I_C=0.8\text{A}$	$T_a=25^\circ\text{C}$	15	25				
			$T_a=125^\circ\text{C}$	10	14				
		$V_{CE}=1\text{V}, I_C=2\text{A}$	$T_a=25^\circ\text{C}$	6	9				
			$T_a=125^\circ\text{C}$	4	6				
		$V_{CE}=2.5\text{V}, I_C=1\text{A}$	$T_a=25^\circ\text{C}$	18	25				
			$T_a=125^\circ\text{C}$	14	18				
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=0.8\text{A}, I_B=0.08\text{A}$	$T_a=25^\circ\text{C}$		0.35	0.5	V		
			$T_a=125^\circ\text{C}$		0.55	0.75	V		
		$I_C=2\text{A}, I_B=0.4\text{A}$	$T_a=25^\circ\text{C}$		0.47	0.75	V		
			$T_a=125^\circ\text{C}$		0.9	1.1	V		
		$I_C=0.8\text{A}, I_B=0.04\text{A}$	$T_a=25^\circ\text{C}$		0.9	1.5	V		
			$T_a=125^\circ\text{C}$		1.8	2.5	V		
		$I_C=1\text{A}, I_B=0.2\text{A}$	$T_a=25^\circ\text{C}$		0.22	0.5	V		
			$T_a=125^\circ\text{C}$		0.3	0.6	V		
		$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C=0.8\text{A}, I_B=0.08\text{A}$	$T_a=25^\circ\text{C}$		0.8	1.0	V
					$T_a=125^\circ\text{C}$		0.65	0.9	V
$I_C=2\text{A}, I_B=0.4\text{A}$	$T_a=25^\circ\text{C}$				0.9	1.0	V		
	$T_a=125^\circ\text{C}$				0.8	0.9	V		
$C_{ib}$	Input Capacitance	$V_{EB}=10\text{V}, I_C=0.5\text{A}, f=1\text{MHz}$		550	750	pF			
$C_{ob}$	Output Capacitance	$V_{CB}=10\text{V}, I_E=0, f=1\text{MHz}$		60	100	pF			
$f_T$	Current Gain Bandwidth Product	$I_C=0.5\text{A}, V_{CE}=10\text{V}$		11		MHz			
$V_F$	Diode Forward Voltage	$I_F=1\text{A}, I_C=1\text{mA}, I_E=0$	$T_a=25^\circ\text{C}$		0.86	1.3	V		
			$T_a=125^\circ\text{C}$		0.79		V		
		$I_F=2\text{A}$	$T_a=25^\circ\text{C}$		0.95	1.5	V		
			$T_a=125^\circ\text{C}$		0.88		V		
$t_{fr}$	Diode Forward Recovery Time ( $di/dt=10\text{A}/\mu\text{s}$ )	$I_F=0.4\text{A}$		460		ns			
		$I_F=1\text{A}$		360		ns			
		$I_F=2\text{A}$		325		ns			
$V_{CE(DSAT)}$	Dynamic Saturation Voltage	$I_C=1\text{A}, I_{B1}=100\text{mA}$ $V_{CC}=300\text{V}$ at $1\mu\text{s}$	$T_a=25^\circ\text{C}$		8		V		
			$T_a=125^\circ\text{C}$		15		V		
		$I_C=1\text{A}, I_{B1}=100\text{mA}$ $V_{CC}=300\text{V}$ at $3\mu\text{s}$	$T_a=25^\circ\text{C}$		2.9		V		
			$T_a=125^\circ\text{C}$		8		V		
		$I_C=2\text{A}, I_{B1}=400\text{mA}$ $V_{CC}=300\text{V}$ at $1\mu\text{s}$	$T_a=25^\circ\text{C}$		9		V		
			$T_a=125^\circ\text{C}$		17		V		
		$I_C=2\text{A}, I_{B1}=400\text{mA}$ $V_{CC}=300\text{V}$ at $3\mu\text{s}$	$T_a=25^\circ\text{C}$		1.9		V		
			$T_a=125^\circ\text{C}$		8.5		V		

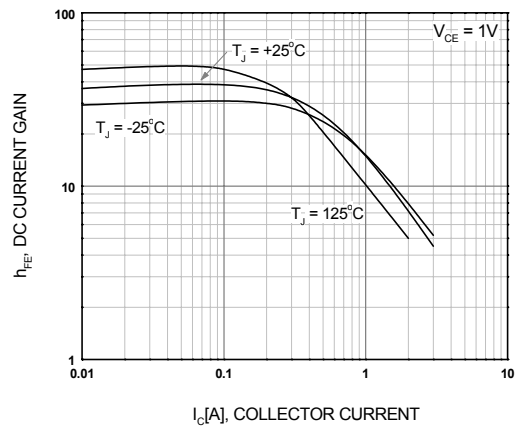
**Electrical Characteristics** (Continued)  $T_a=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Condition	Min	Typ.	Max.	Units	
RESISTIVE LOAD SWITCHING (D.C. $\leq$ 10%, Pulse Width=40 $\mu$ s)							
$t_{ON}$	Turn On Time	$I_C=2.5\text{A}$ , $I_{B1}=500\text{mA}$ , $I_{B2}=-1\text{A}$ , $V_{CC}=250\text{V}$ , $R_L = 100\Omega$		500	750	ns	
$t_{STG}$	Storage Time		1.2		1.5	$\mu$ s	
$t_F$	Fall Time			100	200	ns	
$t_{ON}$	Turn On Time	$I_C=2\text{A}$ , $I_{B1}=400\text{mA}$ , $I_{B2}=-1\text{A}$ , $V_{CC}=300\text{V}$ , $R_L = 150\Omega$	$T_a=25^\circ\text{C}$	100	150	ns	
			$T_a=125^\circ\text{C}$		150	ns	
$t_{STG}$	Storage Time		$T_a=25^\circ\text{C}$	1.4	2.2	$\mu$ s	
			$T_a=125^\circ\text{C}$		1.7	$\mu$ s	
$t_F$	Fall Time		$T_a=25^\circ\text{C}$		90	150	ns
			$T_a=125^\circ\text{C}$		150	ns	
$t_{ON}$	Turn On Time	$I_C=2.5\text{A}$ , $I_{B1}=500\text{mA}$ , $I_{B2}=-5\text{mA}$ , $V_{CC}=300\text{V}$ , $R_L = 120\Omega$	$T_a=25^\circ\text{C}$		120	150	ns
			$T_a=125^\circ\text{C}$		150	ns	
$t_{STG}$	Storage Time		$T_a=25^\circ\text{C}$	1.8		2.1	$\mu$ s
			$T_a=125^\circ\text{C}$		2.6	$\mu$ s	
$t_F$	Fall Time		$T_a=25^\circ\text{C}$		110	150	ns
			$T_a=125^\circ\text{C}$		160	ns	
INDUCTIVE LOAD SWITCHING ( $V_{CC}=15\text{V}$ )							
$t_{STG}$	Storage Time	$I_C=2.5\text{A}$ , $I_{B1}=500\text{mA}$ , $I_{B2}=-0.5\text{A}$ , $V_Z=350\text{V}$ , $L_C=300\mu\text{H}$	$T_a=25^\circ\text{C}$		1.9	2.2	$\mu$ s
			$T_a=125^\circ\text{C}$		2.4	$\mu$ s	
$t_F$	Fall Time		$T_a=25^\circ\text{C}$		160	200	ns
			$T_a=125^\circ\text{C}$		330	ns	
$t_C$	Cross-over Time		$T_a=25^\circ\text{C}$		350	500	ns
			$T_a=125^\circ\text{C}$		750	ns	
$t_{STG}$	Storage Time	$I_C=2\text{A}$ , $I_{B1}=400\text{mA}$ , $I_{B2}=-0.4\text{A}$ , $V_Z=300\text{V}$ , $L_C=200\mu\text{H}$	$T_a=25^\circ\text{C}$	1.95		2.25	$\mu$ s
			$T_a=125^\circ\text{C}$		2.9	$\mu$ s	
$t_F$	Fall Time		$T_a=25^\circ\text{C}$		120	150	ns
			$T_a=125^\circ\text{C}$		270	ns	
$t_C$	Cross-over Time		$T_a=25^\circ\text{C}$		300	450	ns
			$T_a=125^\circ\text{C}$		700	ns	
$t_{STG}$	Storage Time	$I_C=1\text{A}$ , $I_{B1}=100\text{mA}$ , $I_{B2}=-0.5\text{A}$ , $V_Z=300\text{V}$ , $L_C=200\mu\text{H}$	$T_a=25^\circ\text{C}$		0.6	0.8	$\mu$ s
			$T_a=125^\circ\text{C}$		1.0	$\mu$ s	
$t_F$	Fall Time		$T_a=25^\circ\text{C}$		70	ns	
			$T_a=125^\circ\text{C}$		110	ns	
$t_C$	Cross-over Time		$T_a=25^\circ\text{C}$		80	130	ns
			$T_a=125^\circ\text{C}$		170	ns	

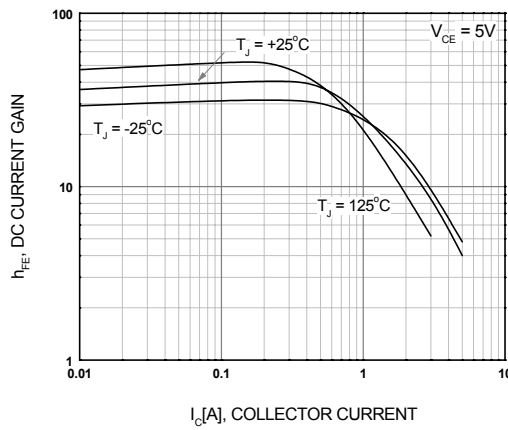
## Typical Characteristics



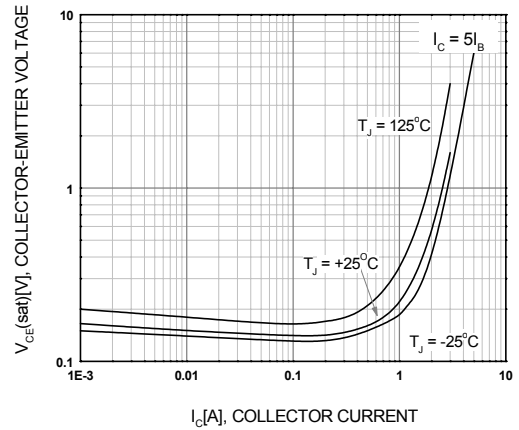
**Figure 1. Static Characteristic**



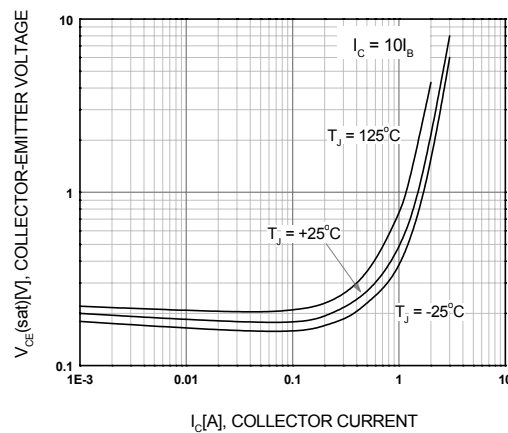
**Figure 2. DC current Gain**



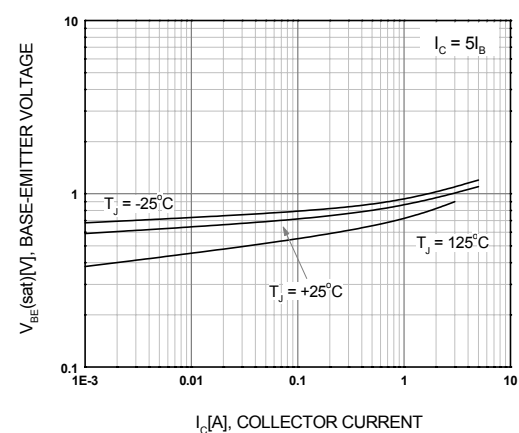
**Figure 3. DC current Gain**



**Figure 4. Collector-Emitter Saturation Voltage**

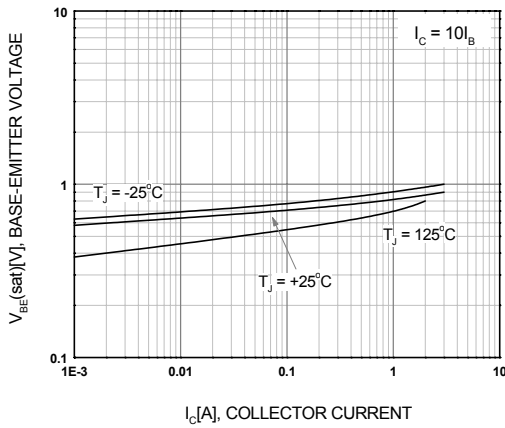


**Figure 5. Collector-Emitter Saturation Voltage**

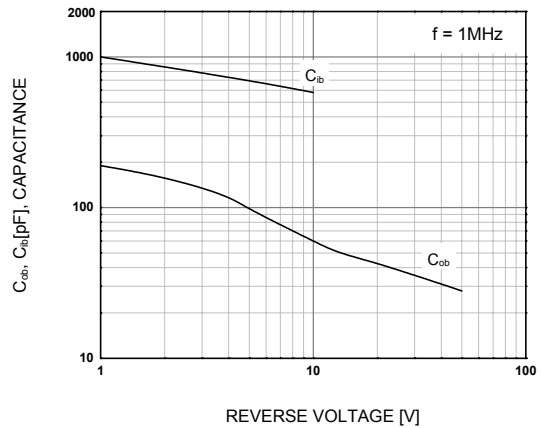


**Figure 6. Base-Emitter Saturation Voltage**

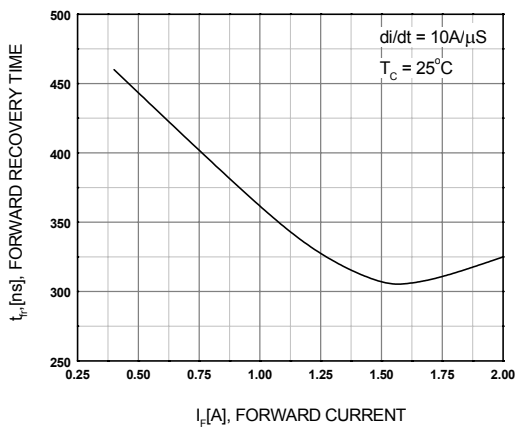
**Typical Characteristics (Continued)**



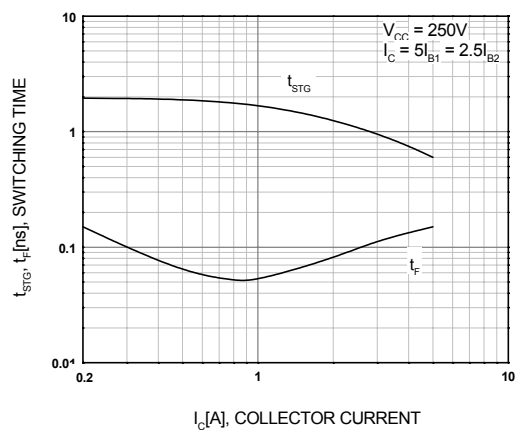
**Figure 7. Base-Emitter Saturation Voltage**



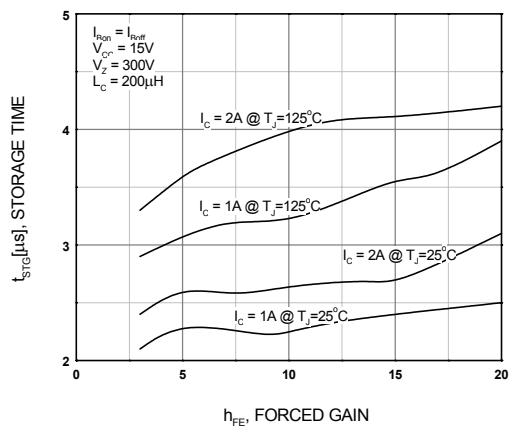
**Figure 8. Collector Output Capacitance**



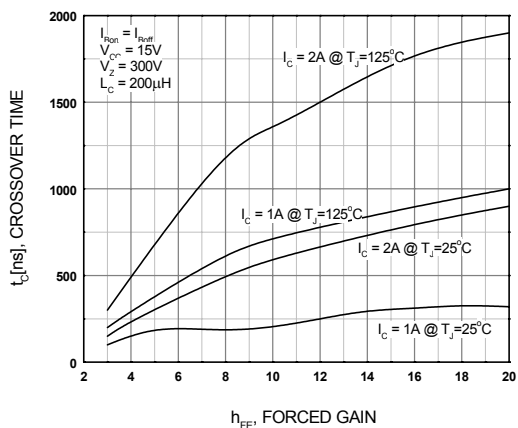
**Figure 9. Forward Recovery Time**



**Figure 10. Switching Time**

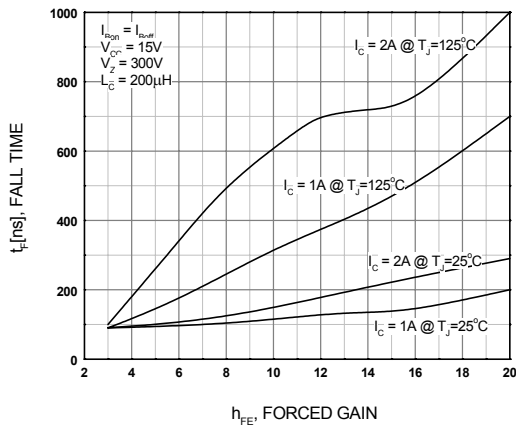


**Figure 11. Induction Storage Time**

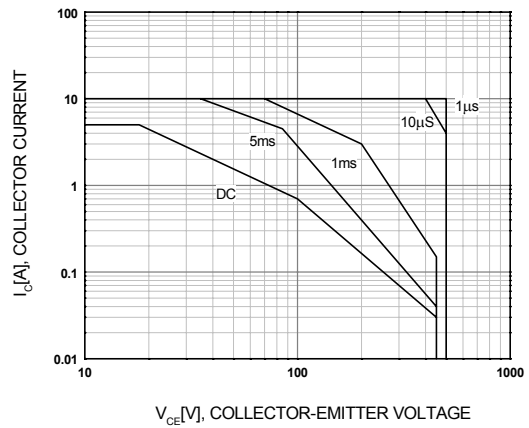


**Figure 12. Inductive Crossover Time**

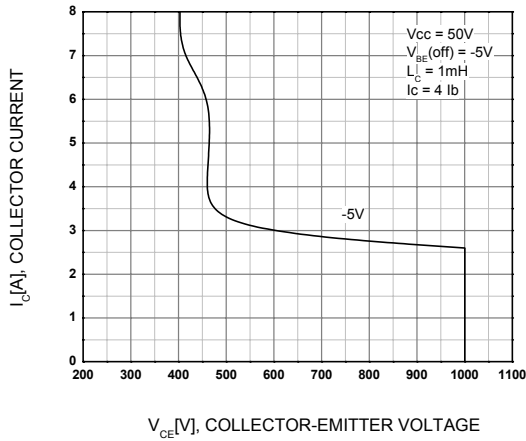
### Typical Characteristics (Continued)



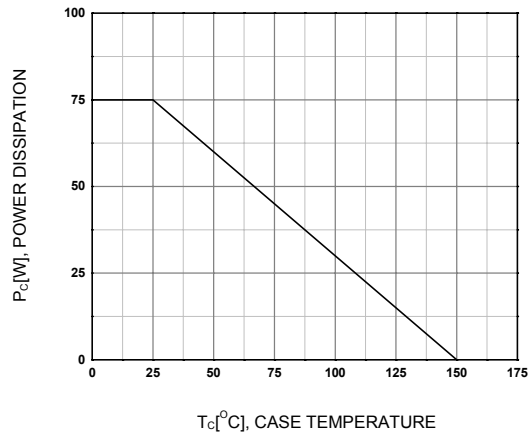
**Figure 13. Inductive Fall Time**



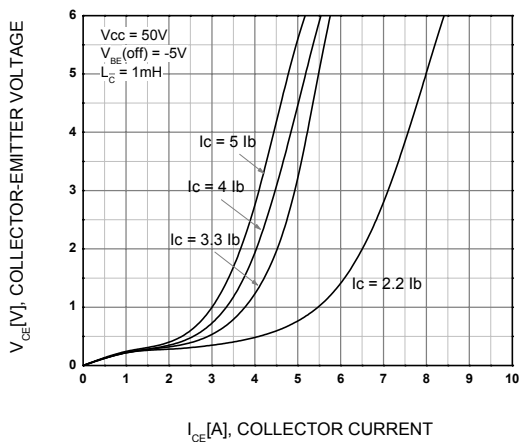
**Figure 14. Safe Operating Area**



**Figure 15. Reverse Bias Safe Operating**



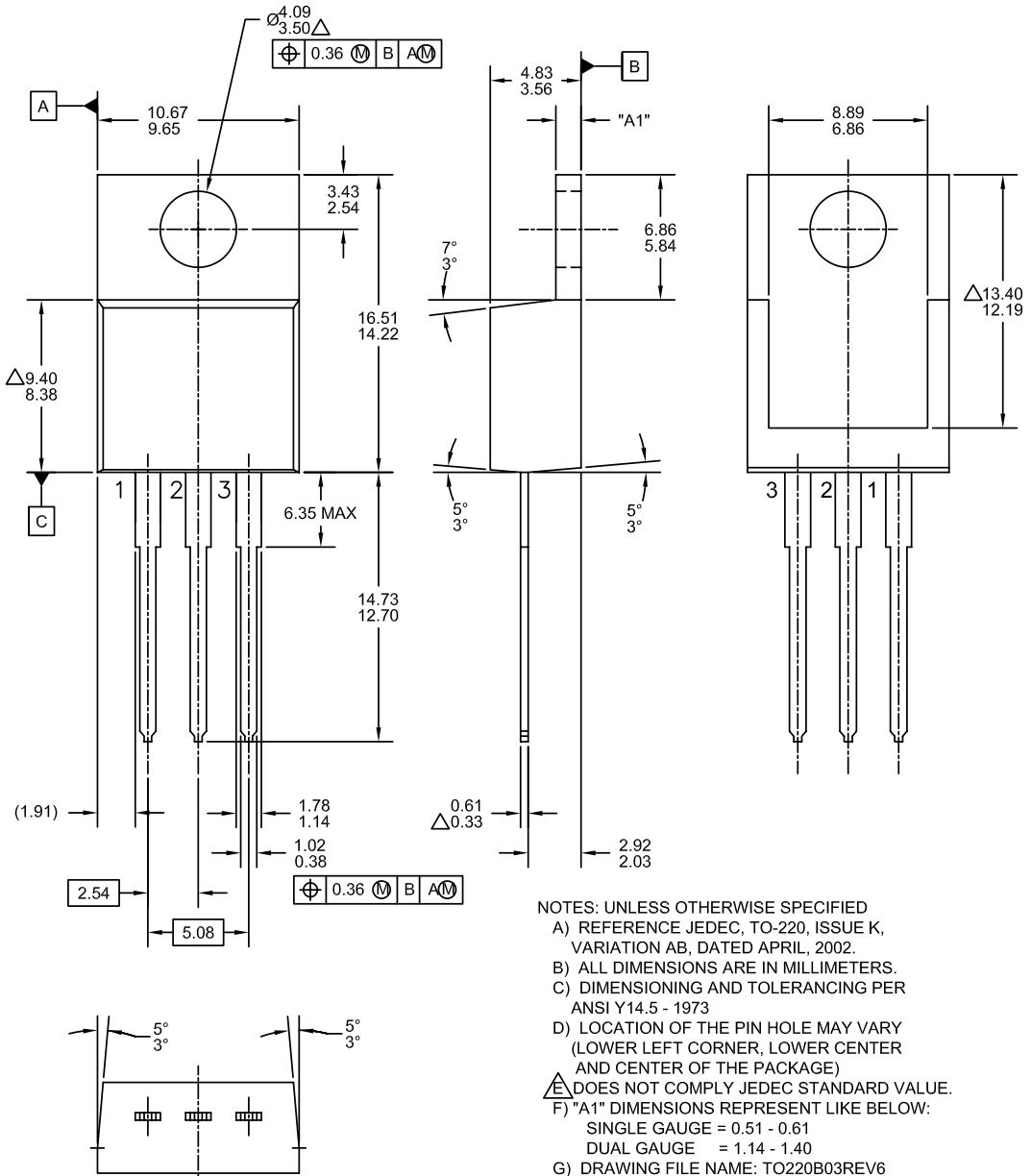
**Figure 16. Power Derating**



**Figure 17. RBSOA Saturation**

**Physical Dimensions**

**TO-220**








NOTES: UNLESS OTHERWISE SPECIFIED  
 A) REFERENCE JEDEC, TO-220, ISSUE K, VARIATION AB, DATED APRIL, 2002.  
 B) ALL DIMENSIONS ARE IN MILLIMETERS.  
 C) DIMENSIONING AND TOLERANCING PER ANSI Y14.5 - 1973  
 D) LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE)  
 $\Delta$  DOES NOT COMPLY JEDEC STANDARD VALUE.  
 F) "A1" DIMENSIONS REPRESENT LIKE BELOW:  
 SINGLE GAUGE = 0.51 - 0.61  
 DUAL GAUGE = 1.14 - 1.40  
 G) DRAWING FILE NAME: T0220B03REV6

Dimensions in Millimeters



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### Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I49





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Электрон  
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